

[54] **PACKING BOX FOR HEADPHONE**
[75] **Inventor: Yuhko Nakamura, Yokohama, Japan**
[73] **Assignee: Sony Corporation, Tokyo, Japan**
[**] **Term: 14 Years**
[21] **Appl. No.: 452,327**
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[30] **Foreign Application Priority Data**
Jun. 28, 1989 [JP] Japan 1-23901
[52] **U.S. Cl. D9/415**
[58] **Field of Search D9/415, 418, 424, 337;**
206/461, 462, 471, 307; D14/223, 299

[56] **References Cited**
U.S. PATENT DOCUMENTS
D. 227,081 6/1973 Alexander D9/415
D. 227,229 6/1973 Funahashi D9/415
D. 244,301 5/1977 Besasie D14/223
D. 270,617 9/1983 Skowronski et al. D9/415
D. 313,753 1/1991 Nagasaka D9/415
3,664,493 5/1972 Dutcher 206/45.31 X

3,939,979 2/1976 Neumayer 206/470 X
4,630,734 12/1986 Severin et al. 206/468 X
4,890,761 1/1990 Gaves 220/462

OTHER PUBLICATIONS

Packaging Catalog, Dec. 1975, p. 63, circled passage.
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[57] **CLAIM**
The ornamental design for a packing box for head-
phone, as shown and described.

DESCRIPTION

FIG. 1 is a top, front and right-side perspective view of a packing box for headphone, showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left-side elevational view thereof; FIG. 5 is a right-side elevational view thereof; FIG. 6 is a top plan view thereof; and FIG. 7 is a bottom plan view thereof.

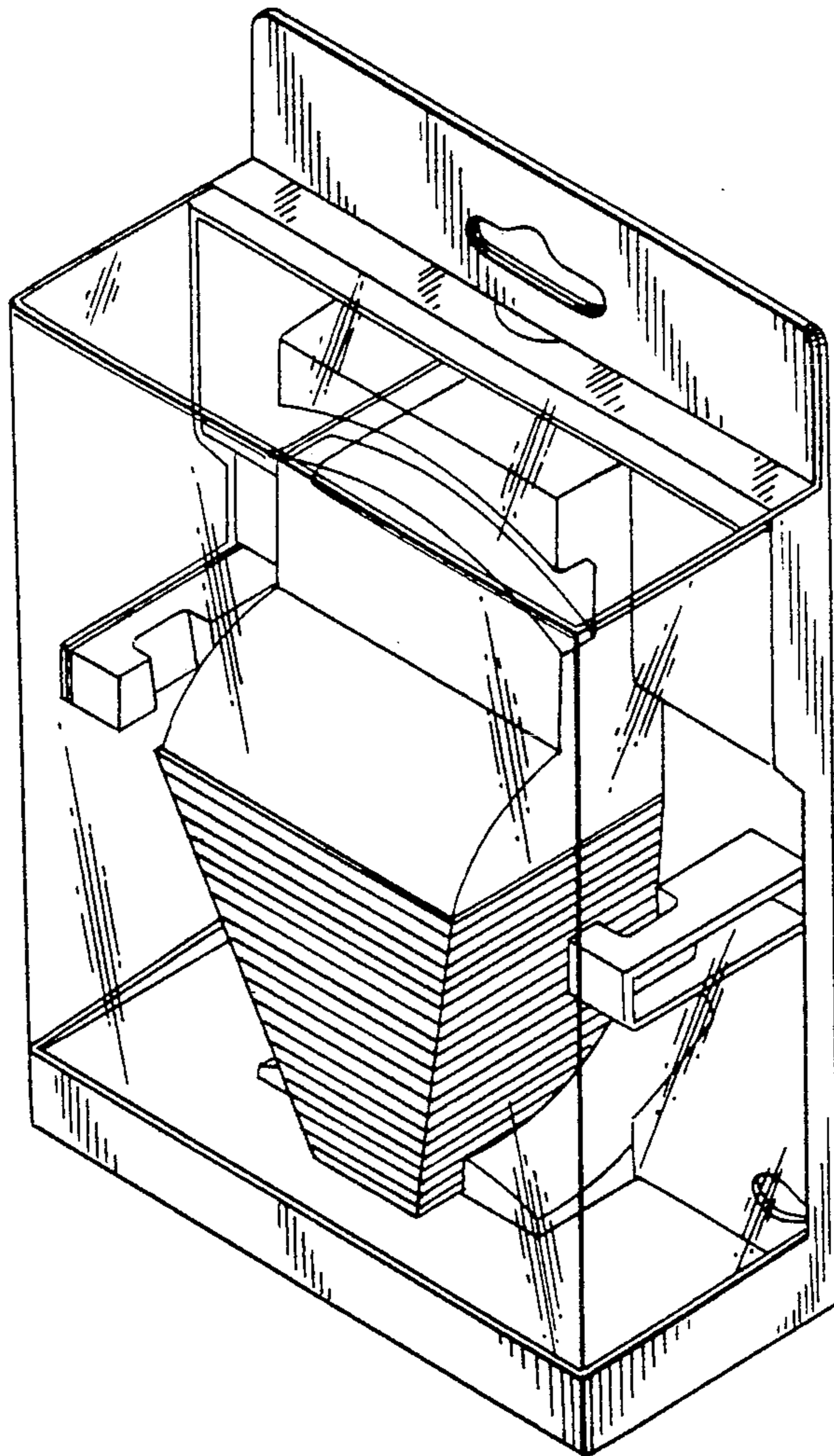


FIG. 1

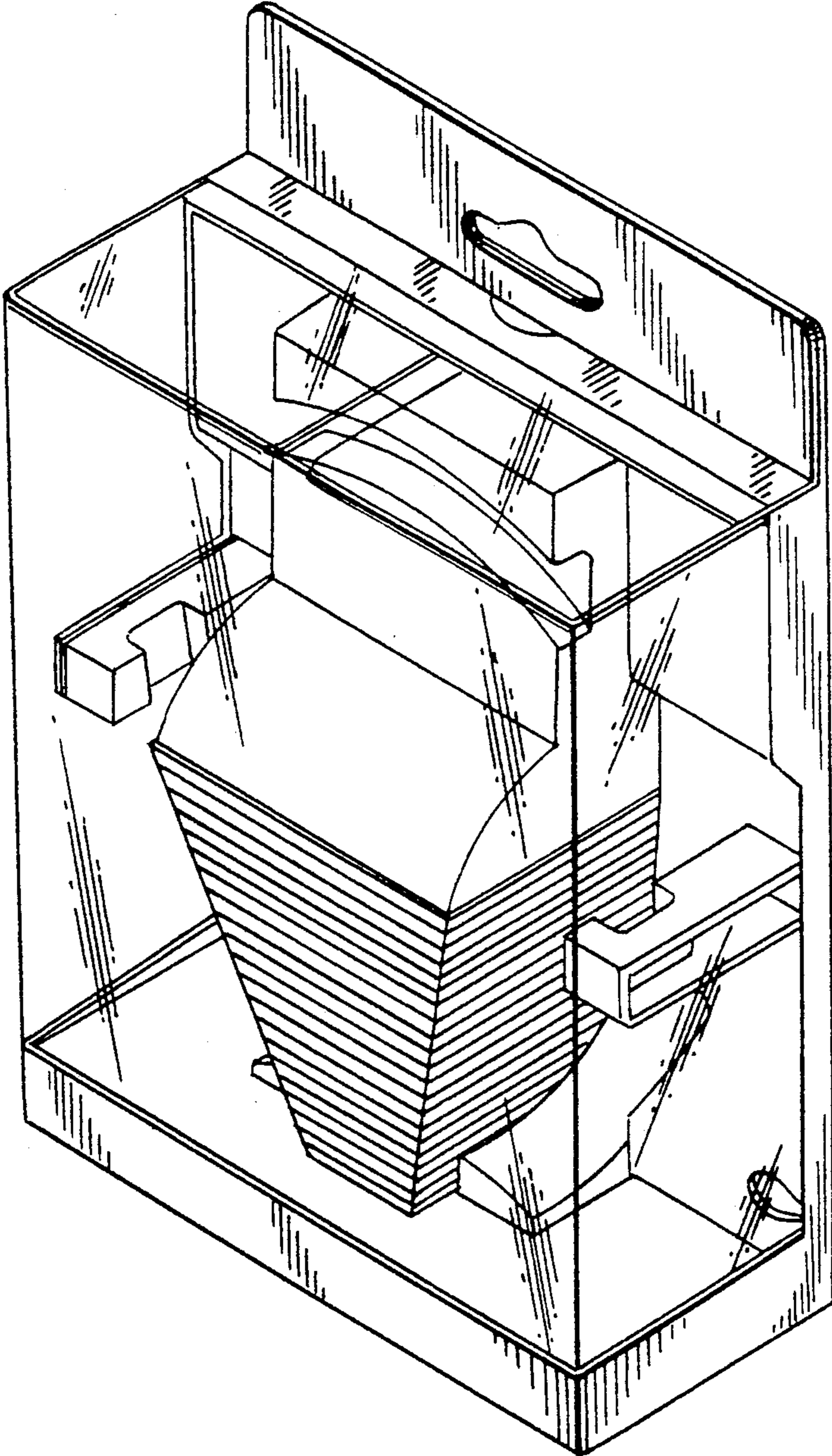


FIG. 2

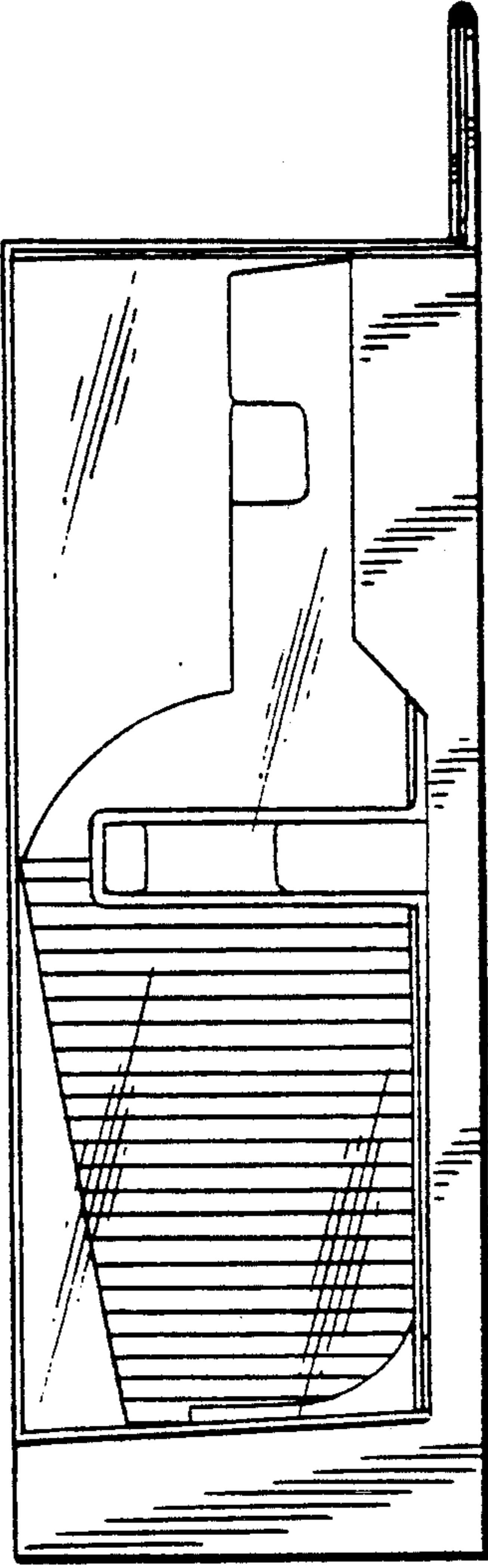
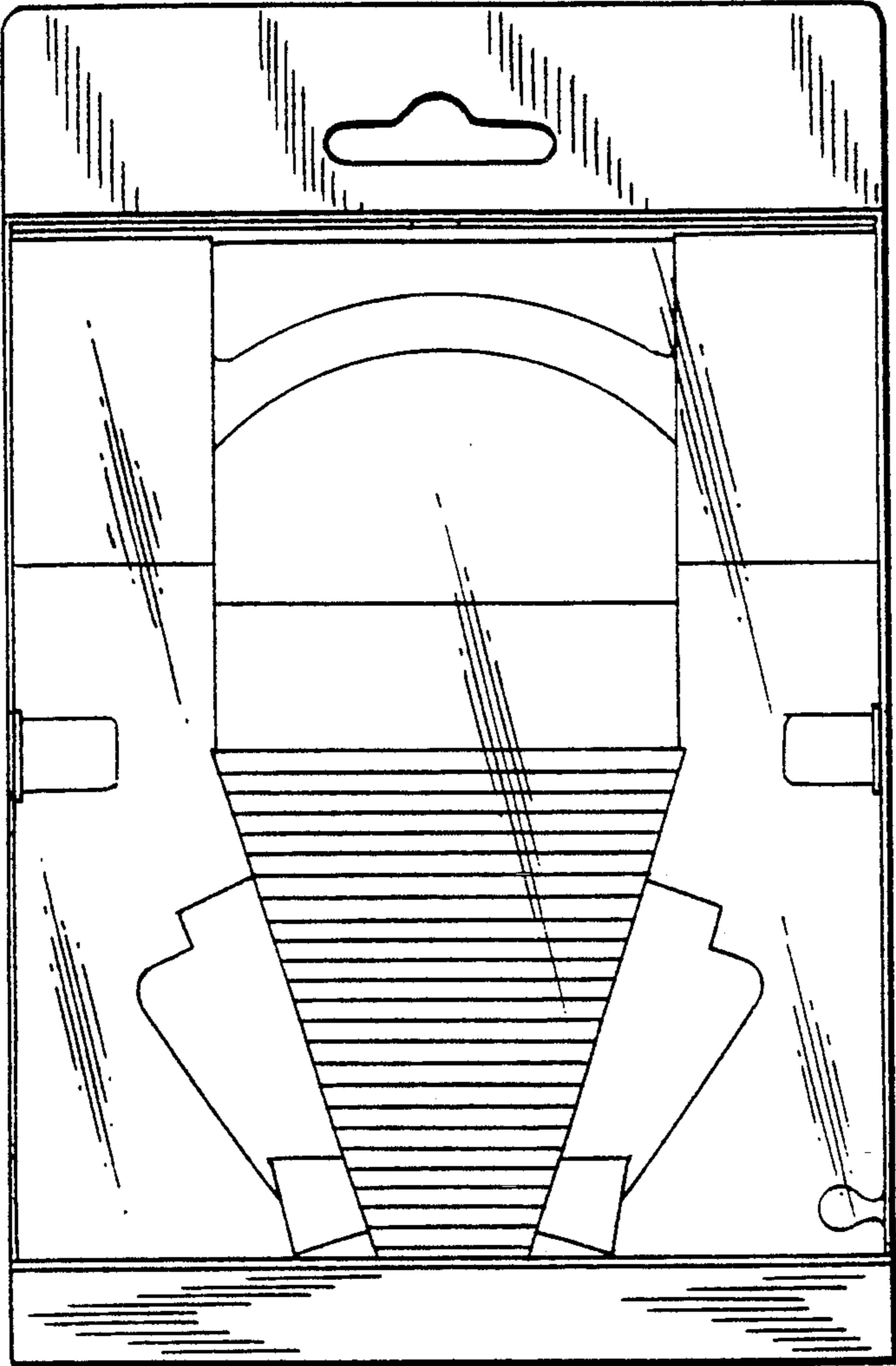


FIG. 5

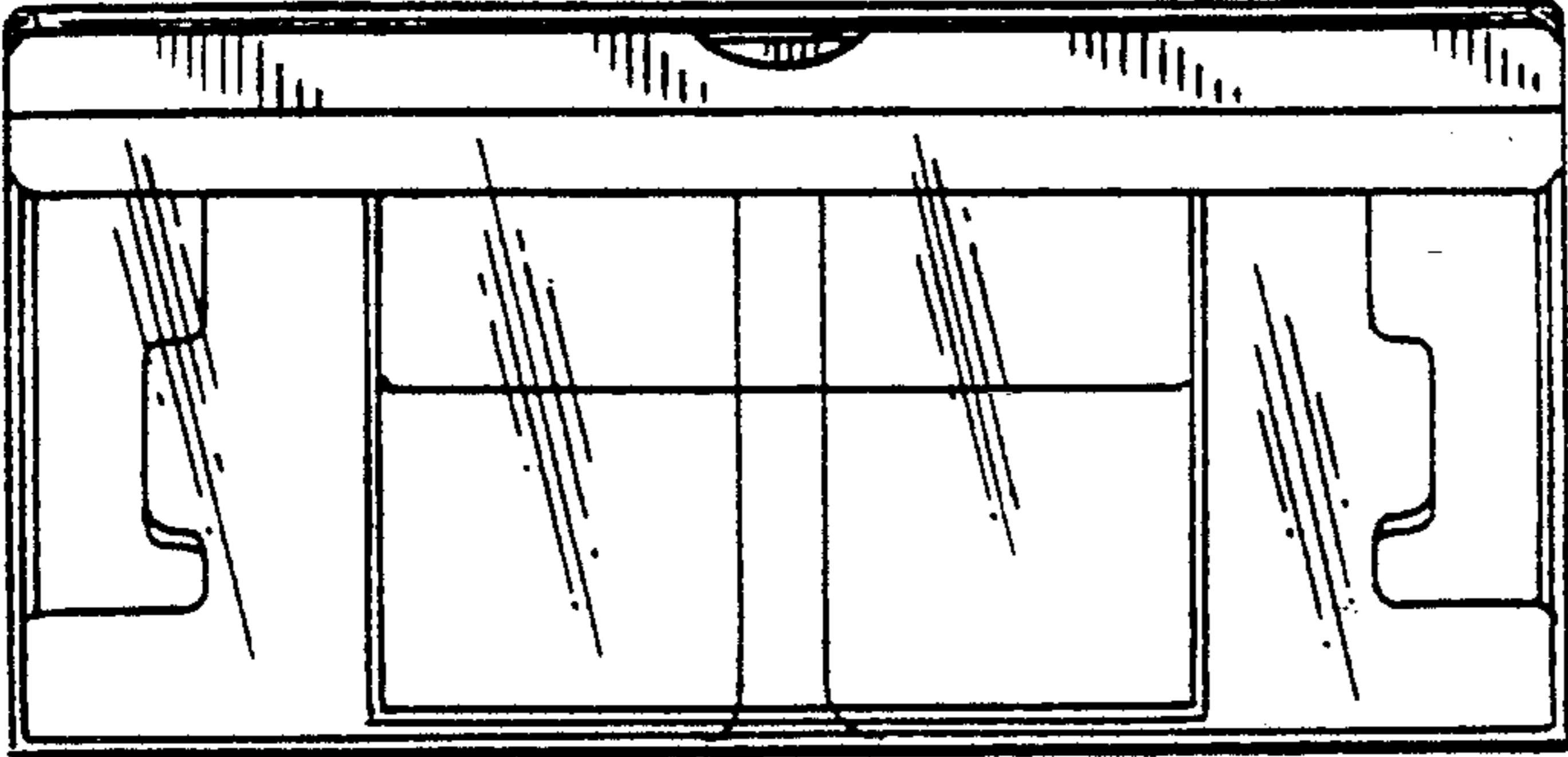


FIG. 6

FIG. 3

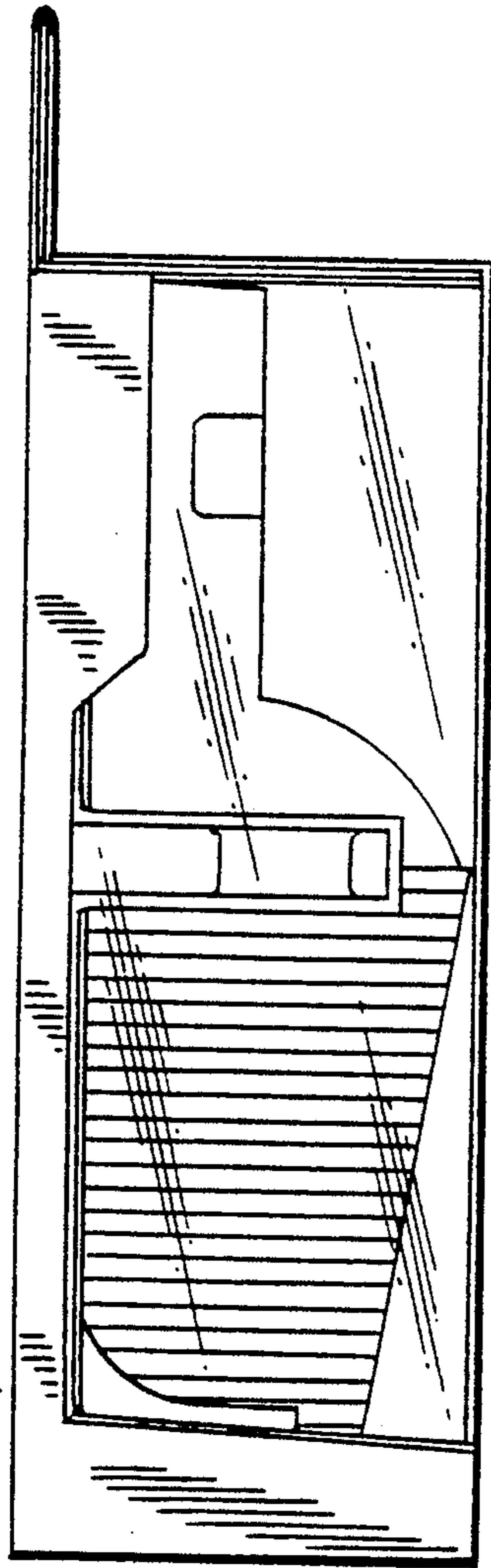
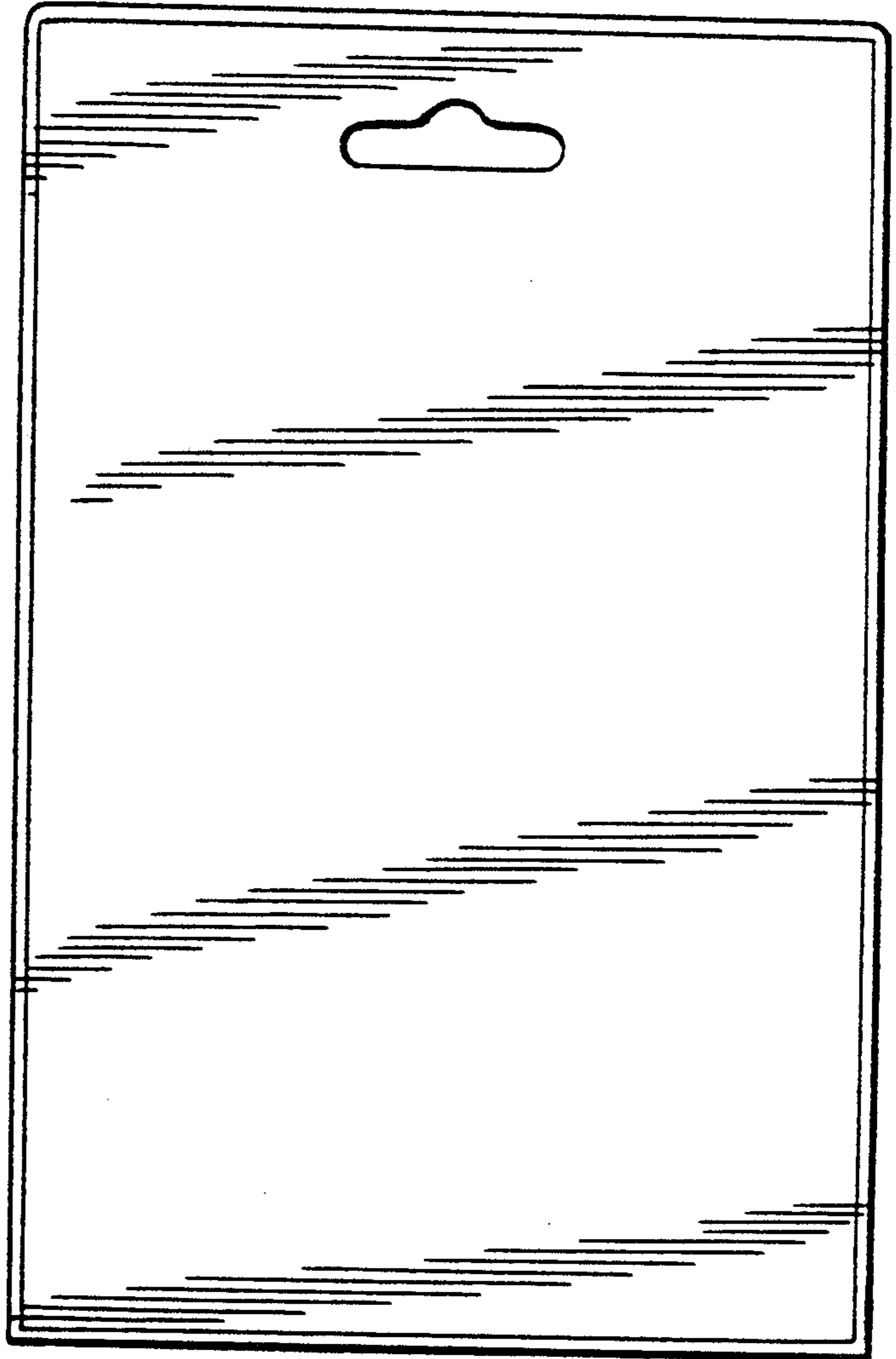


FIG. 4

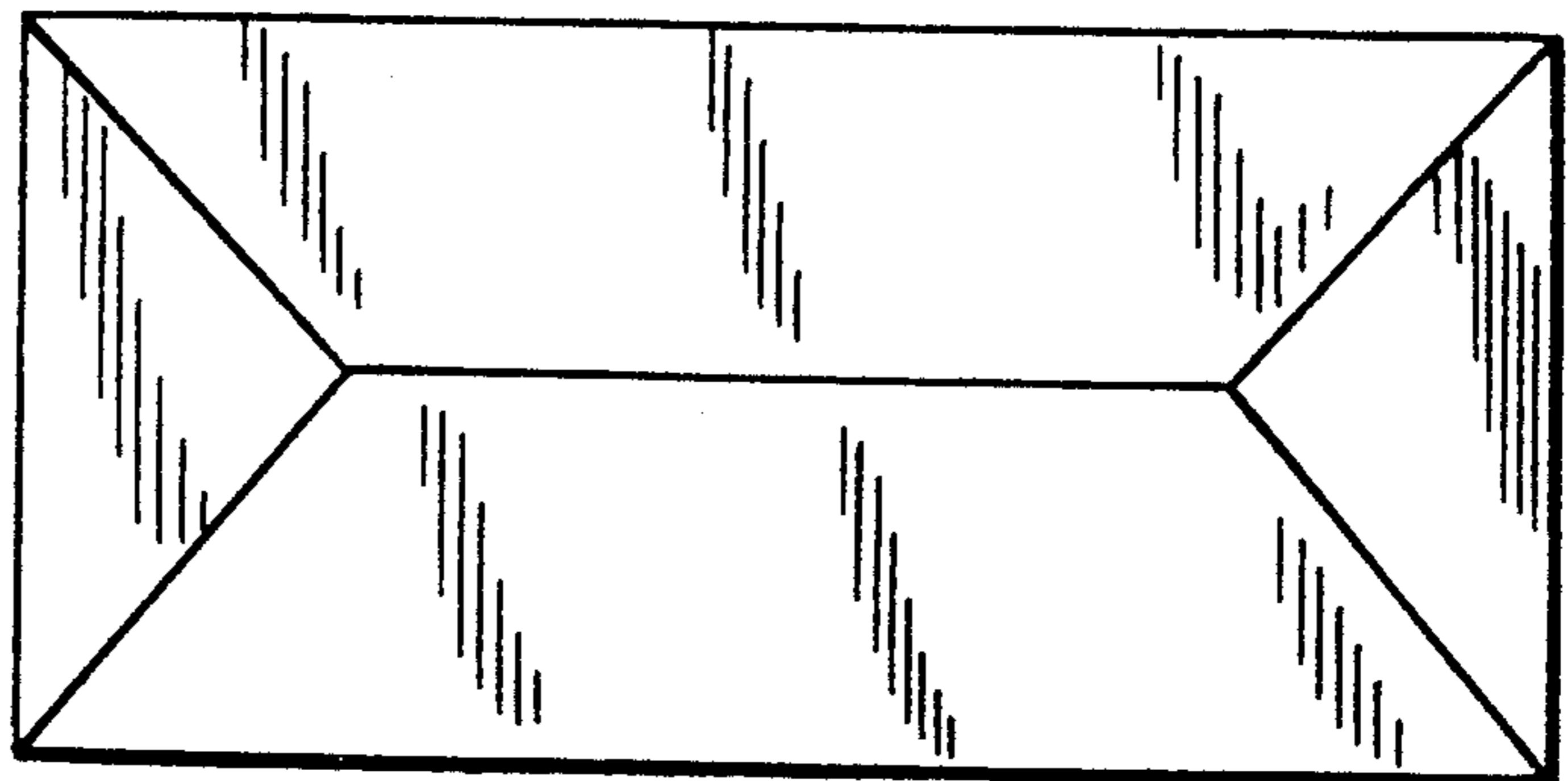


FIG. 7